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Messrs. Digi-Key

Issue	٩N	lo.	: F	P-O	)2-(	045

Date of issue: November 15, 2002

Classification: ■ New □ Change □ Renewal

### **Delivery Specification**

Product Description	: Directional Coupler
Product Part Number	: EHF4CM1747
Classification of Spec	: Individual Product Specification
Applications	: Cellular phone
	For other applications, contact the undersigned in advance.
Term of Validity	: November 14, 2007 from the date of issue.

CUSTOMER USE ONLY	Receipt Record#:
This was certainly received by us.  1(one) copy is being returned to you.	Date of receipt:
	Received by:
	Title: Dept.:

Matsushita Electronic Components Co., Ltd. Network Device Company Module Strategic Business Unit Engineering Group HFD Team

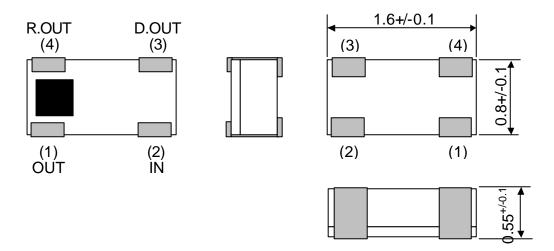
992-1 Aiba Ohno-cho Ibi-gun Gifu 501-0598 JAPAN

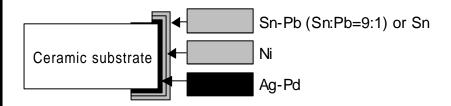
Tel: +81-0585-36-2322 Fax: +81-0585-36-2344 Prepared by : S.Endo Checked by : M. Mizuno

Authorized by : M. Mizuno

Title : Manager of Engineering

[Shape, appearance, dimension] Unit: mm <Top view> <Bottom and side view>





Note 1) "typ" is used where no dimensional tolerance applies.

Item	Description							
Appearance/ construction	Product surface shall be covered with a protective film, which does not easily separate nor present noticeable unevenness, scratches, pinholes color changes etc.							
	Terminals shall ensure practically acceptable quality.							
	Substrate shall be as shown in the drawing with no excessive chippings, scratches, burrs, or cracks.							
Marking	Shall be legible in black (with printing paste).							
Remarks	marked side for pin 1.							

Directional Coupler		Delivery Specification			EHF4CM1747		
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan	Appearance		
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo	Drawing No. 151-EHF-4CM1747 9-1		

#### [Absolute maximum ratings]

No.	Item	Symbol	Rating	Unit	Remarks
1	Maximum input power	Pmax	3	V	DC bias must be 0V.
2	Operating temperature	Topr	-30+85	degC	
3	Storage temperature	Tstg	-40+85	degC	

Note: This component cannot apply a DC Bias.

#### [Electrical characteristics]

T=+25 +/- 5 degC

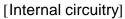
Additional

56 ohm

Resitor

No.	Item	Test	Test Specification					
		Circuit	Min.	Тур.	Max.			
1	Frequency	-	1710	1747.5	1785	MHz		
2	Insertion loss 2-7	Fig-1	-	-	*0.35	dB		
3	Coupling 2-3	Fig-1	13	14	15	dB		
4	Isolation 1-3	Fig-1	22	-	-	dB		
5	Input VSWR	Fig-1	-	-	1.3	-		

<sup>\*</sup> Value of insertion loss is not included the Test Board Loss(0.2dB)





#### [Measuring circuit]

- < Insertion loss & VSWR measurement >
- (2)IN=Port1, (1)OUT=Port2
- (3) Detect OUT is connected 50 ohm.
- < Coupling measurement >
- (2)IN=Port1, (3)Detect OUT=Port2
- (1)OUT is connected 50 ohm.
- < Isolation measurement >
- (1)OUT=Port1, (3)Detect OUT=Port2

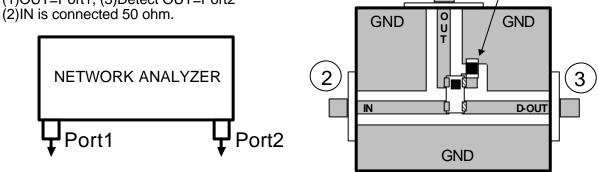


FIG.1

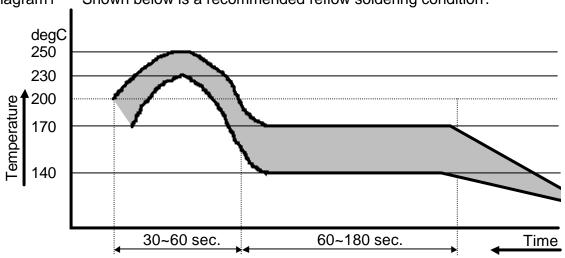
Directional Coupler		Deliver	y Specifi	cation	EHF4CM1747		
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan	Specification and meas	surement	
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo	Drawing No. 151-EHF-4CM174	7 9-2	

## [Terminal dimensions] Unit: mm <Bottom> Pin No. (4) (3) 0.2+/-0.1 Bottom View (2) 0.35<sup>+/-0.15</sup> (1) 0.35<sup>+/-0.15</sup> 0.75+/-0.2 [Recommended PCB pad dimensions] Unit: mm (4)R OUT (3)D OUT 0.48 PCB Pad 1.36 Product Top View 0.48 (1)OUT (2)IN 0.75 0.6 0.75 2.1

Directional Coupler		Deliver	ry Specif	ication	EHF4CM1747
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan	Terminals/Recommended lands
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[Quality characteristic	s]							
Test item	Test condition	Judgment criteria						
High temperature	+85degC, 1000h	No abnormality shall						
Low temperature	-40degC, 1000 h	be observed in appearance or						
High-temperature high-humidity storage	+60degC, 90%RH, 1000h	electrical characteristics.						
Pressure Pot	+121degC, 99%RH, 2.026x10 <sup>5</sup> Pa, 100h	characteristics.						
Temperature cycling	-40+85degC, Each 30 min., 200cy							
Vibration	10500Hz, 10G, in each direction of XYZ, 2h30min.							
Impact	100G, 6mS, Half sinusoidal wave, in each direction of XYZ, 3 times							
Shock (Drop)	hock (Drop) 1.8m, 6 facesx6cy(36 times with 100g Dummy Load)							
Electro static discharge	lectro static discharge 200pF, 0 ohm, +/-200V, Each 5 times							
Soldering heat resistance	Manual hot gas: 260+/-10degC, 30 sec., 2 times	Over 90% of the terminal surface shall be covered with solder.						
	Soldering iron: 260+/-10degC, 3 sec., 2 times							
	Reflow: 260degC peak, 2 times							
Solder ability	Solder bath: 235+/-5degC, 2 sec.	Over 95% of the terminal surface shall be covered with solder.						
	Reflow: 230degC							
Board warping	Assemble this component on a PC board with 0.8mm thickness using the recommended soldering condition shown below, and apply a bending force of 3mm warping at a rate of 1mm/sec. 5 seconds and 5 times.	There should not be any cracks in the component or solder joints, no abnormality in electrical characteristics.						
Terminal removal  Solder a component on a PC board using the recommended condition shown below a then press the component sideways at 1mm/sec. Destruction limit 4.9N or greater.								
Seating plane co-planarity Within 0.1mm								





Directional Coupler		Deliver	y Specif	ication	EHF4CM1747		
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#### [Cautions for use]

- (1) Operating a product over the maximum rating for even a moment may result in a product failure or breakage. Never use a product in such a condition that it may cause a safety problem.
- (2) Opening or short-circuiting the product terminals or inserting a product in the reverse orientation while power is being supplied may cause a breakage. Always avoid such circumstances.
- (3) Operations in a corrosive gas atmosphere or improper environments such as high-temperature, high-humidity or dewy conditions may lead to product performance deterioration, a breakage, a change in appearance etc. Please avoid such conditions, as they are unsafe.
- (4) Always ground the soldering iron or soldering bath used for assembly operation to avoid any excessive voltage applied to a product.
- (5) After soldering with solder bridges, incomplete soldering or in the reverse orientation, supplying power may result in a product breakage. Please confirm the soldered condition before supplying power to the product.
- (6) Excessive stress on the terminals may cause a contact failure or performance deterioration. Please use caution.
- (7) Please provide a fail-safe provision in the product you design by taking any failure of our product into consideration.
- (8) This product does not include a DC-cutting device. Application of a DC Current may cause product deterioration or breakage.
  - \* If any question arises about the safety of this product, please contact us immediately with a request for an engineering examination.

#### [Remarks]

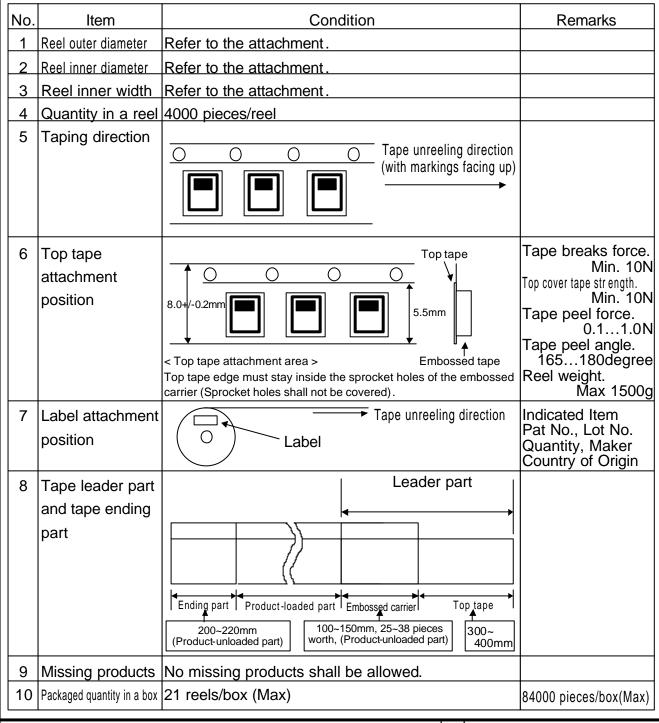
- \*1: All of the materials used in this product are those listed as the existing chemical substances based on the "Law for examination and regulation of manufacture of chemical substances".
- \*2: The production process of this product does not use any ozone-depleting chemicals (OZC) regulated by the Montreal Protocol.
- \*3: Validity of this specification is 5 years from the date of issue, but the validity is considered on going unless any changes are made.

Directional Coupler		Delivery Specification EHF				EHF4CM1747	
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan		Cautions	
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo		Drawing No. 151-EHF-4CM1747 9-5	

#### [Packaging materials]

- 1. Materials
- 1) Embossed carrier tape (Refer to the attachment)
- 2) Top tape: Anti-static
- 3) Packaging box (Refer to the attachment)
- 4) Packaging tape, carrier-securing adhesive tape

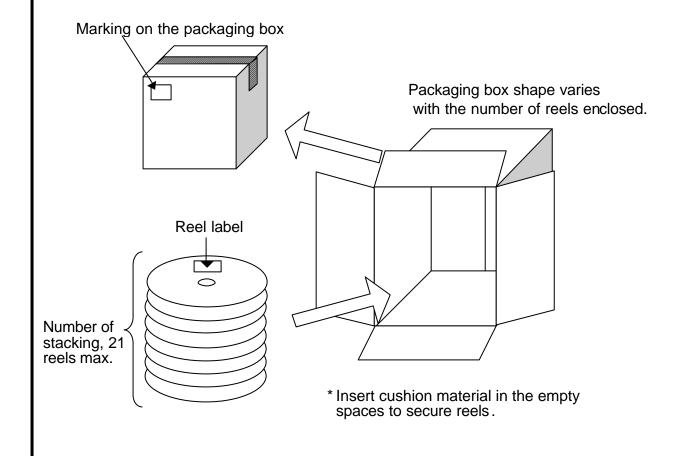
#### 2. Specification



Directional Coupler	onal Coupler Delivery Specification					EHF4CM1747	
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan		Packaging specification 1	
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo		Drawing No. 151-EHF-4CM1747 9-6	

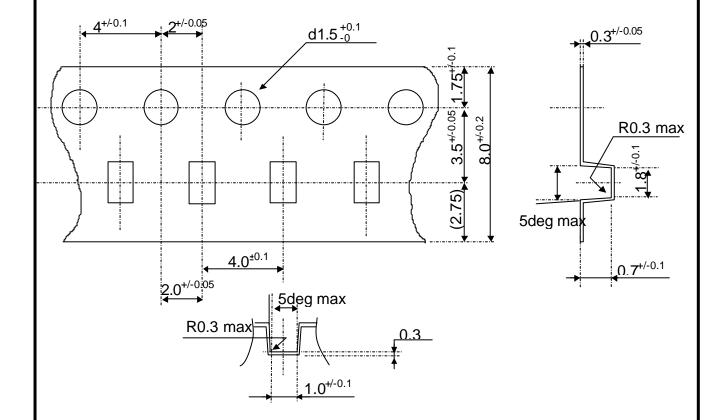
#### 1. Method

- 1) Load products in each cavity of an embossed carrier tape, in the correct orientation, by leaving the product-unloaded part shown in Item No. 8(P9-6) of the packaging specification.
- 2) Heat-seal a top tape in good alignment on the carrier tape.
- 3) After 4000 pieces are loaded and reeled, provide a product-unloaded part at the tape-leader portion. Secure the tip of the carrier tape with a piece of adhesive tape.
- 4) Stack the reels (21 reels max.) and enclose them in a packaging box. Close the flaps with a piece of adhesive tape.
- 5) Provide markings on the packaging box.
  - < Items to be indicated >
    - 1. Part No.
    - 2. Quantity
    - 3. Lot No.
    - 4. Manufacturer name
    - 5. Country of origin



Directional Coupler	Delivery Specification					EHF4CM1747	
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan		Packaging specification 2	
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo		Drawing No. 151-EHF-4CM1747 9-7	

### [Embossed tape dimensions] Unit: mm



#### <Remarks>

- (1) Unspecified corner radius shall be 0.3mm max.
- (2) Cumulative pitch error of sprocket holes shall be +/-0.2mm for 10 pitches.

Directional Coupler	Delivery Specification					EHF4CM1747	
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan		Packaging specification 3	
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo		Drawing No. 151-EHF-4CM1747 9-8	

